

DERWENT-ACC-NO: 1992-284626
DERWENT-WEEK: 199910
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TITLE: Polyacetal base resin compsn. with dispersed
polyolefin resin - having
improved acid resistance, fusibility with polyolefin resin
and mechanical
properties

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PATENT-ASSIGNEE: POLYPLASTICS KK[POPL]

PRIORITY-DATA: 1991JP-0026948 (January 28, 1991)

PATENT-FAMILY:

PUB-NO	PUB-DATE	LANGUAGE
PAGES	MAIN-IPC	
WO 9213028 A1	August 6, 1992	J
023	C08J 003/20	
JP 2854150 B2	February 3, 1999	N/A
007	C08J 003/20	
JP 04252232 A	September 8, 1992	N/A
007	C08J 003/20	
EP 522180 A1	January 13, 1993	E
013	C08J 003/20	
BR 9203917 A	June 8, 1993	N/A
000	C08J 003/20	
TW 236626 A	December 21, 1994	N/A
000	C08K 003/00	
EP 522180 A4	September 15, 1993	N/A
000	C08J 003/20	

DESIGNATED-STATES: BR CA KR US AT BE CH DE DK ES FR GB GR
IT LU MC NL SE AT BE C
H DE DK ES FR GB GR IT LI LU MC NL SE

CITED-DOCUMENTS: JP 53108142; JP 60223852 ; No-Citns. ; EP
159904 ; US 4649172

APPLICATION-DATA:

PUB-NO	APPL-DESCRIPTOR	APPL-NO
APPL-DATE		

WO 9213028A1	N/A	1992WO-JP00077
January 28, 1992		
JP 2854150B2	N/A	1991JP-0026948
January 28, 1991		
JP 2854150B2	Previous Publ.	JP 4252232
N/A		
JP 04252232A	N/A	1991JP-0026948
January 28, 1991		
EP 522180A1	N/A	1992EP-0903747
January 28, 1992		
EP 522180A1	N/A	1992WO-JP00077
January 28, 1992		
EP 522180A1	Based on	WO 9213028
N/A		
BR 9203917A	N/A	1992BR-0003917
January 28, 1992		
BR 9203917A	N/A	1992WO-JP00077
January 28, 1992		
BR 9203917A	Based on	WO 9213028
N/A		
TW 236626A	N/A	1992TW-0100591
January 28, 1992		
EP 522180A4	N/A	1992EP-0903747
N/A		

INT-CL (IPC): C08J003/20; C08J005/00 ; C08K003/00 ;
 C08K007/00 ;
 C08L023/00 ; C08L059/00 ; C08L059/04 ; C08L023:08 ;
 C08L059/00

ABSTRACTED-PUB-NO: WO 9213028A

BASIC-ABSTRACT: Compsn. has a network structure in which components (A) and (B) are dispersed in each other. (A) is a polyacetal resin which acts as a matrix.

(B) is a polyolefin resin. When (A) is melt mixed with (B), a filler (C) is added in an amt. such that the relations given by equations $(B)/(A+B) = 0.05-0.5$ (wt.) (pref. $0.10-0.40$ wt.) (1) and $(C)/(B+C) = 0.1-0.7$ (wt.) (2) are satisfied. (C) has a surface tension which is at least greater than that of (B) at the melt mixing temp. and a mean particulate dia. of $0.05-50$ microns.

(B) is pref. polyethylene or a copolymer comprising polyethylene as major

component. (C) can be glass fibre, asbestos fibre, silica fibre, silica, alumina fibre, zirconia fibre, boron nitride fibre, silicon nitride fibre, B fibre, potassium titanate fibre, etc. or C black, silicate, glass beads, glass balloon, glass powder, talc, etc.. (C) can also be a resin such as aromatic polyester resin, aromatic polyamide resin, aromatic polyimide resin, polystyrene resin, acrylic resin, epoxy resin, etc..

USE/ADVANTAGE - The method is simple and is low cost. The mould obtd. from the compsn. retains the properties of polyacetal and has improved resistance against acid, fusibility with polyolefin resin and mechanical propertie

CHOSEN-DRAWING: Dwg.0/3

TITLE-TERMS:

POLYACETAL BASE RESIN COMPOSITION DISPERSE POLYOLEFIN RESIN
IMPROVE ACID
RESISTANCE FUSE POLYOLEFIN RESIN MECHANICAL PROPERTIES

DERWENT-CLASS: A17 A25

CPI-CODES: A04-G01B; A05-H03A; A07-A04E; A08-R01;

UNLINKED-DERWENT-REGISTRY-NUMBERS: 1521U; 1541U ; 1544U ;
1668U ; 1694U ; 1893U
; 5023U ; 5085U ; 5213U ; 5214U ; 5311U

POLYMER-MULTIPUNCH-CODES-AND-KEY-SERIALS:

Key Serials: 0009 0011 0016 0020 0045 0069 0072 0075 0171
0205 0218 0219 0224
0226 0232 0233 0239 0240 0304 0486 0487 1275 1282 1283 1285
1291 1511 2208 2211
2214 2215 2217 2218 2219 2220 2266 2315 2321 2332 2334 2510
2541 2545 2599 2607
2612 2617 2621 2629 2635 2662
Multipunch Codes: 014 02& 032 034 040 041 046 047 055 056
06- 07& 074 08& 080
081 09& 09- 10& 138 141 143 144 15- 151 180 20- 226 229 247
27- 305 307 308 309
310 311 314 329 364 365 392 393 394 396 437 44& 441 476 531

541 545 551 556 560

567 573 597 603 654 681 684 688 721 722 723

SECONDARY-ACC-NO:

CPI Secondary Accession Numbers: C1992-126618